

TOSHIBA CMOS Linear Integrated Circuit Silicon Monolithic

# TCR3DM series

## 300 mA CMOS Low Dropout Regulator with inrush current protection circuit

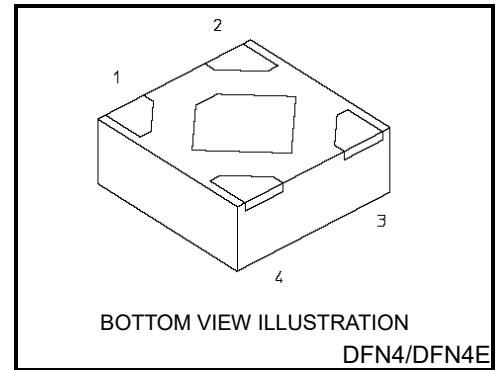
The TCR3DM series are CMOS general-purpose single-output voltage regulators with an on/off control input, featuring low dropout voltage, low output noise voltage and low inrush current.

These voltage regulators are available in fixed output voltages between 1.0 V and 4.5 V and capable of driving up to 300 mA.

They feature over-current protection, over-temperature protection, Inrush current protection circuit and Auto-discharge function.

The TCR3DM series are offered in the ultra small plastic mold package DFN4/DFN4E (1.0 mm x 1.0 mm; t 0.58 mm). It has a low dropout voltage of 210 mV (2.5 V output,  $I_{OUT} = 300$  mA) with low output noise voltage of 38  $\mu$ Vrms (2.5 V output) and a load transient response of only  $\Delta V_{OUT} = \pm 80$  mV ( $I_{OUT} = 1$  mA  $\leftrightarrow$  300 mA,  $C_{OUT} = 1.0$   $\mu$ F).

As small ceramic input and output capacitors can be used with the TCR3DM series, these devices are ideal for portable applications that require high-density board assembly such as cellular phones.



Weight : 1.3 mg ( typ.)

## Features

- Low Dropout voltage
  - $V_{DO} = 210$  mV (typ.) at 2.5 V-output,  $I_{OUT} = 300$  mA
  - $V_{DO} = 270$  mV (typ.) at 1.8 V-output,  $I_{OUT} = 300$  mA
  - $V_{DO} = 490$  mV (typ.) at 1.2 V-output,  $I_{OUT} = 300$  mA
- Low output noise voltage
  - $V_{NO} = 38$   $\mu$ Vrms (typ.) at 2.5 V-output,  $I_{OUT} = 10$  mA,  $10$  Hz  $\leq f \leq 100$  kHz
- Fast load transient response ( $\Delta V_{OUT} = \pm 80$  mV (typ.) at  $I_{OUT} = 1$  mA  $\leftrightarrow$  300 mA,  $C_{OUT} = 1.0$   $\mu$ F)
- High ripple rejection (R.R = 70 dB (typ.) at 2.5 V-output,  $I_{OUT} = 10$  mA,  $f = 1$  kHz)
- Overcurrent protection
- Over-temperature protection
- Inrush current protection circuit
- Auto-discharge
- Pull down connection between CONTROL and GND
- Ceramic capacitors can be used ( $C_{IN} = 1.0$   $\mu$ F,  $C_{OUT} = 1.0$   $\mu$ F)
- Ultra small package DFN4/DFN4E (1.0 mm x 1.0 mm ; t 0.58 mm)

Start of commercial production  
2013-03

### Absolute Maximum Ratings (Ta = 25°C)

Characteristics	Symbol	Rating	Unit
Input voltage	V <sub>IN</sub>	6.0	V
Control voltage	V <sub>CT</sub>	-0.3 to 6.0	V
Output voltage	V <sub>OUT</sub>	-0.3 to V <sub>IN</sub> + 0.3	V
Output current	I <sub>OUT</sub>	300	mA
Power dissipation	P <sub>D</sub>	420 (Note1)	mW
Operating temperature range	T <sub>opr</sub>	-40 to 85	°C
Junction temperature	T <sub>j</sub>	150	°C
Storage temperature range	T <sub>stg</sub>	-55 to 150	°C

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook (“Handling Precautions”/“Derating Concept and Methods”) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

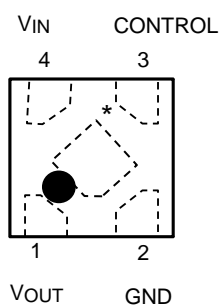
Note1: Rating at mounting on a board

Glass epoxy(FR4) board dimension: 40mm x 40mm x 1.6mm, both sides of board.

Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50%

Through hole hole: diameter 0.5mm x 24

### Pin Assignment (top view)



\*Center electrode should be connected to GND or Open

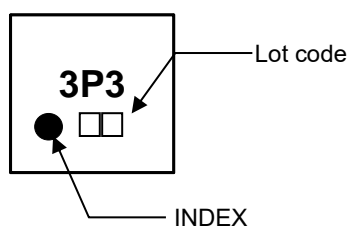
### List of Products Number, Output voltage and Marking

Product No.	Output voltage(V)	Marking	Product No.	Output voltage(V)	Marking
TCR3DM10	1.0	1P0	TCR3DM28	2.8	2P8
TCR3DM105	1.05	1PA	TCR3DM285	2.85	2PD
TCR3DM11	1.1	1P1	TCR3DM30	3.0	3P0
TCR3DM12	1.2	1P2	TCR3DM32	3.2	3P2
TCR3DM13	1.3	1P3	TCR3DM33	3.3	3P3
TCR3DM135	1.35	1PD	TCR3DM35	3.5	3P5
TCR3DM15	1.5	1P5	TCR3DM36	3.6	3P6
TCR3DM18	1.8	1P8	TCR3DM45	4.5	4P5
TCR3DM25	2.5	2P5			

Please contact your local Toshiba representative if you are interested in products with other output voltages .

### Top Marking (top view)

Example: TCR3DM33 (3.3 V output)



### Electrical Characteristics

(Unless otherwise specified,  $V_{IN} = V_{OUT} + 1\text{ V}$ ,  $I_{OUT} = 50\text{ mA}$ ,  $C_{IN} = 1.0\text{ }\mu\text{F}$ ,  $C_{OUT} = 1.0\text{ }\mu\text{F}$ ,  $T_j = 25^\circ\text{C}$ )

Characteristics	Symbol	Test Condition	Min	Typ.	Max	Unit	
Output voltage accuracy	$V_{OUT}$	$I_{OUT} = 50\text{ mA}$ (Note 2)	$V_{OUT} < 1.8\text{ V}$	-18	—	+18	mV
			$1.8\text{ V} \leq V_{OUT}$	-1.0	—	+1.0	%
Input voltage	$V_{IN}$	$I_{OUT} = 300\text{ mA}$	1.75	—	5.5	V	
Line regulation	Reg·line	$V_{OUT} + 0.5\text{ V} \leq V_{IN} \leq 5.5\text{ V}$ , $I_{OUT} = 1\text{ mA}$	—	1	15	mV	
Load regulation	Reg·load	$1\text{ mA} \leq I_{OUT} \leq 300\text{ mA}$	—	18	35	mV	
Quiescent current	$I_B$	$I_{OUT} = 0\text{ mA}$	$V_{OUT} = 1.0\text{ V}$	—	65	—	$\mu\text{A}$
			$V_{OUT} = 1.8\text{ V}$	—	65	—	
			$V_{OUT} = 2.5\text{ V}$	—	68	—	
			$V_{OUT} = 4.5\text{ V}$	—	78	125	
Stand-by current	$I_B$ (OFF)	$V_{CT} = 0\text{ V}$	—	0.1	1	$\mu\text{A}$	
Dropout voltage	$V_{DO}$	$I_{OUT} = 300\text{ mA}$ (Note 3)	—	210	290	mV	
Temperature coefficient	$TCVO$	$-40^\circ\text{C} \leq T_{opr} \leq 85^\circ\text{C}$	—	75	—	ppm/ $^\circ\text{C}$	
Output noise voltage	$V_{NO}$	$V_{IN} = V_{OUT} + 1\text{ V}$ , $I_{OUT} = 10\text{ mA}$ , $10\text{ Hz} \leq f \leq 100\text{ kHz}$ , $T_a = 25^\circ\text{C}$ (Note 3)	—	38	—	$\mu\text{Vrms}$	
Ripple rejection ratio	R.R.	$V_{IN} = V_{OUT} + 1\text{ V}$ , $I_{OUT} = 10\text{ mA}$ , $f = 1\text{ kHz}$ , $V_{Ripple} = 500\text{ mV}_{p-p}$ , $T_a = 25^\circ\text{C}$ (Note 3)	—	70	—	dB	
Load transient response	$\Delta V_{OUT}$	$I_{OUT} = 1\text{ mA} \leftrightarrow 300\text{ mA}$ , $C_{OUT} = 1.0\text{ }\mu\text{F}$	—	$\pm 80$	—	mV	
Control voltage (ON)	$V_{CT}$ (ON)	—	1.0	—	5.5	V	
Control voltage (OFF)	$V_{CT}$ (OFF)	—	0	—	0.4	V	

Note 2: Stable state with fixed  $I_{OUT}$  condition.

Note 3: The 2.5 V output product.

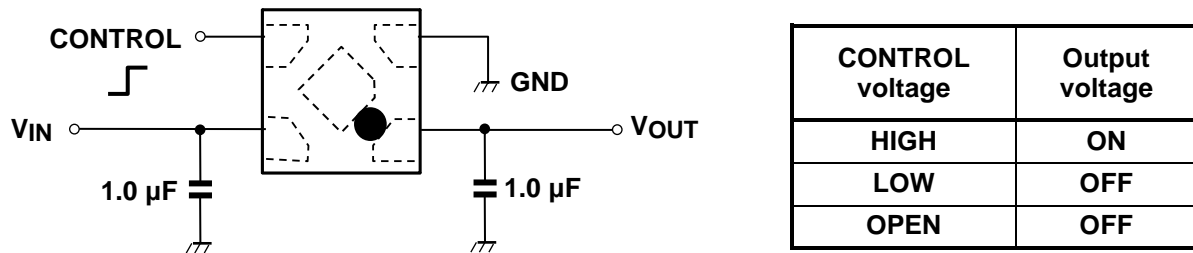
### Dropout voltage

( $I_{OUT} = 300\text{ mA}$ ,  $C_{IN} = 1.0\text{ }\mu\text{F}$ ,  $C_{OUT} = 1.0\text{ }\mu\text{F}$ ,  $T_j = 25^\circ\text{C}$ )

Output voltages	Symbol	Min	Typ.	Max	Unit
1.0 V, 1.05 V	$V_{DO}$	—	590	750	mV
1.1 V		—	550	650	
1.2 V		—	490	600	
1.3 V		—	450	550	
1.35V, 1.4 V		—	390	520	
$1.5\text{ V} \leq V_{OUT} < 1.8\text{ V}$		—	350	450	
$1.8\text{ V} \leq V_{OUT} < 2.1\text{ V}$		—	270	380	
$2.1\text{ V} \leq V_{OUT} < 2.5\text{ V}$		—	240	330	
$2.5\text{ V} \leq V_{OUT} < 2.8\text{ V}$		—	210	290	
$2.8\text{ V} \leq V_{OUT} < 3.2\text{ V}$		—	200	250	
$3.2\text{ V} \leq V_{OUT} < 3.6\text{ V}$		—	180	230	
$3.6\text{ V} \leq V_{OUT} \leq 4.5\text{ V}$		—	150	200	

### Application Note

#### 1. Example of Application Circuit



The figure above shows the example of configuration for using a Low-Dropout regulator. Insert a capacitor at VOUT and VIN pins for stable input/output operation. (Ceramic capacitors can be used.)

#### 2. Power Dissipation

Board-mounted power dissipation ratings for TCR3DM series are available in the Absolute Maximum Ratings table. Power dissipation is measured on the board condition shown below.

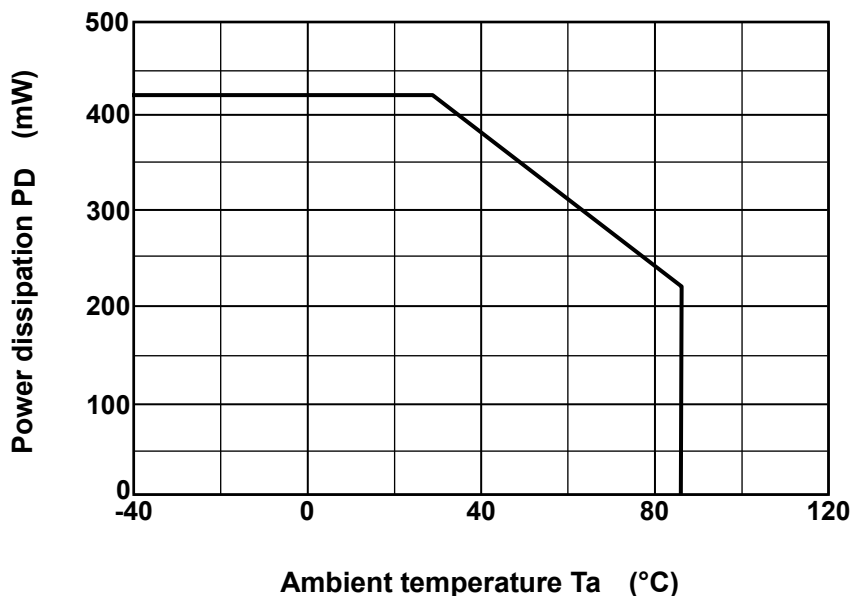
[The Board Condition]

Board material: Glass epoxy(FR4)

Board dimension: 40 mm x 40 mm (both sides of board), t = 1.6 mm

Metal pattern ratio: a surface approximately 50%, the reverse side approximately 50%

Through hole hall: diameter 0.5 mm x 24



### Attention in Use

- Output Capacitors

Ceramic capacitors can be used for these devices. However, because of the type of the capacitors, there might be unexpected thermal features. Please consider application condition for selecting capacitors. And Toshiba recommends the ESR of ceramic capacitor is under 10  $\Omega$ .

- Mounting

The long distance between IC and output capacitor might affect phase compensation by impedance in wire and inductor. For stable power supply, output capacitor need to mount near IC as much as possible. Also VIN and GND pattern need to be large and make the wire impedance small as possible.

- Permissible Loss

Please have enough design patterns for expected maximum permissible loss. And under consideration of ambient temperature, input voltage, output current etc., we recommend proper dissipation ratings for maximum permissible loss; in general maximum dissipation rating is 70 to 80 percent.

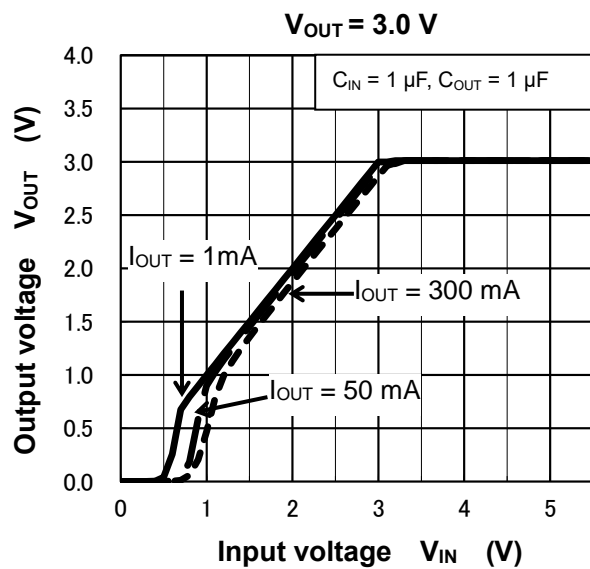
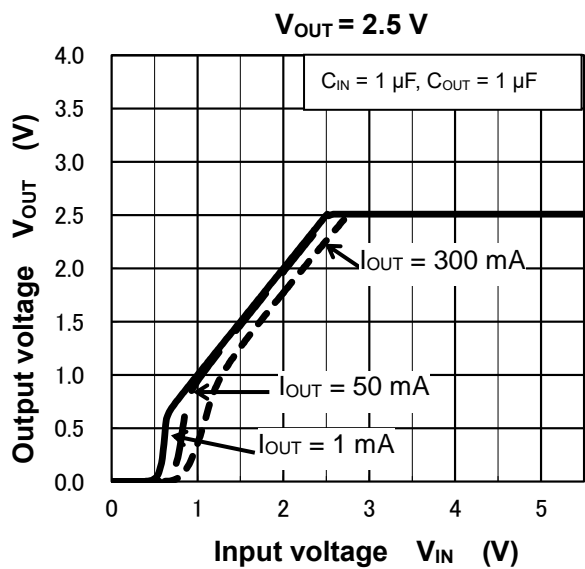
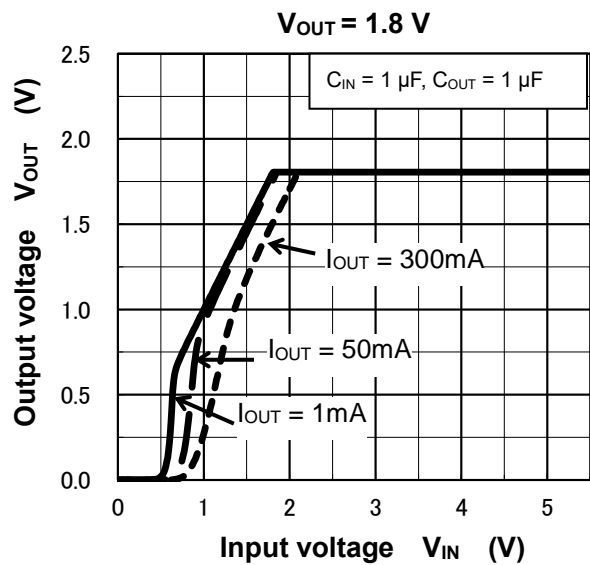
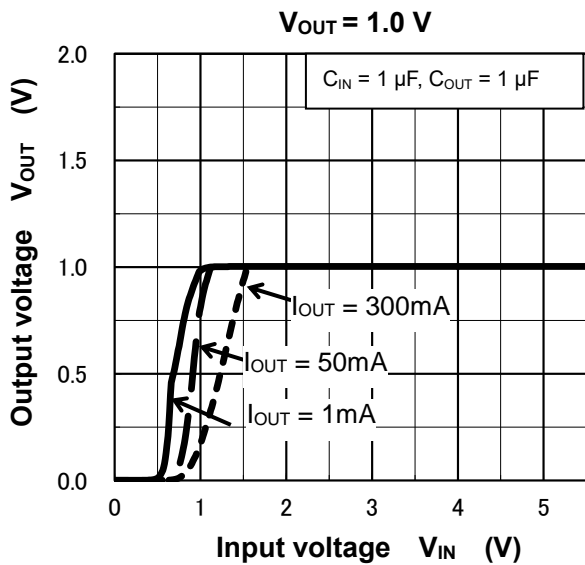
- Over current Protection and Thermal shutdown function

Over current protection and Thermal shutdown function are designed in these products, but these are not designed to constantly ensure the suppression of the device within operation limits. Depending on the condition during actual usage, it could affect the electrical characteristic specification and reliability. Also note that if output pins and GND pins are not completely shorted out, these products might be break down.

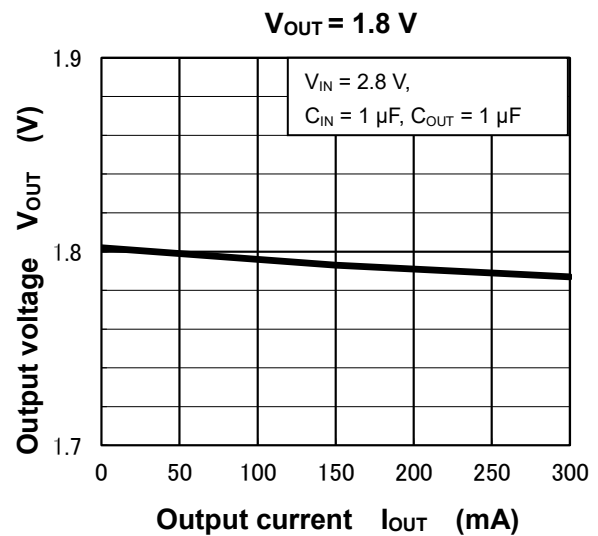
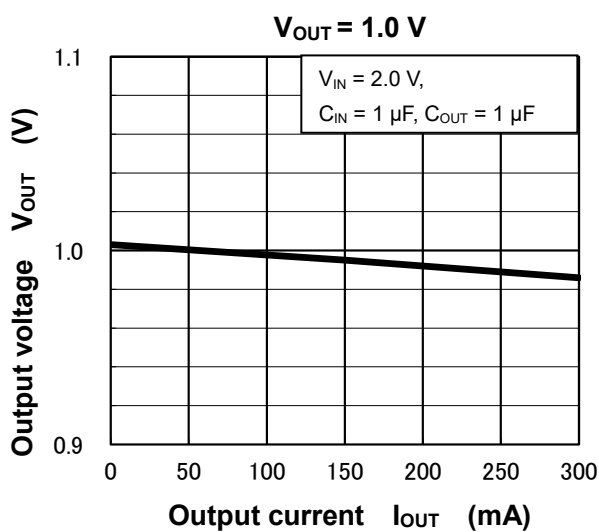
When using these products, please read through and understand the concept of dissipation for absolute maximum ratings from the above mention or our 'Semiconductor Reliability Handbook'. Then use these products under absolute maximum ratings in any condition. Furthermore, Toshiba recommends inserting failsafe system into the design.

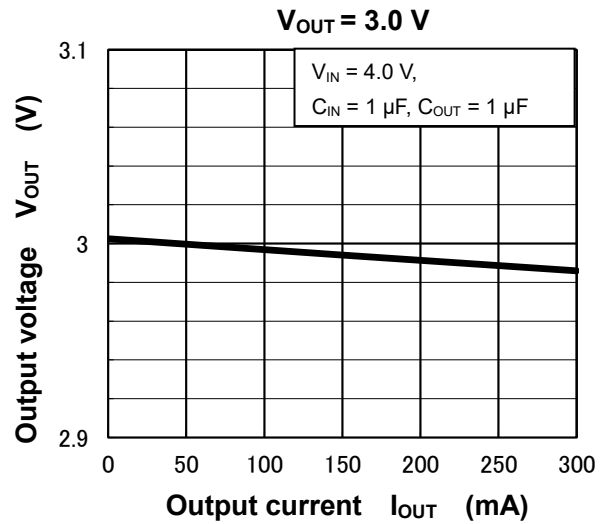
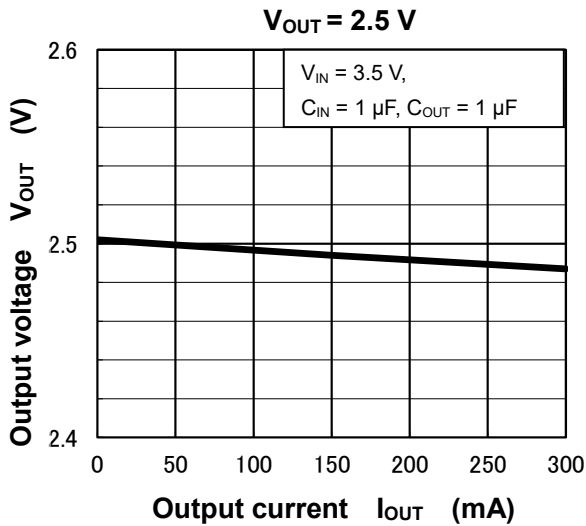
### Representative Typical Characteristics

#### Output Voltage vs. Input Voltage

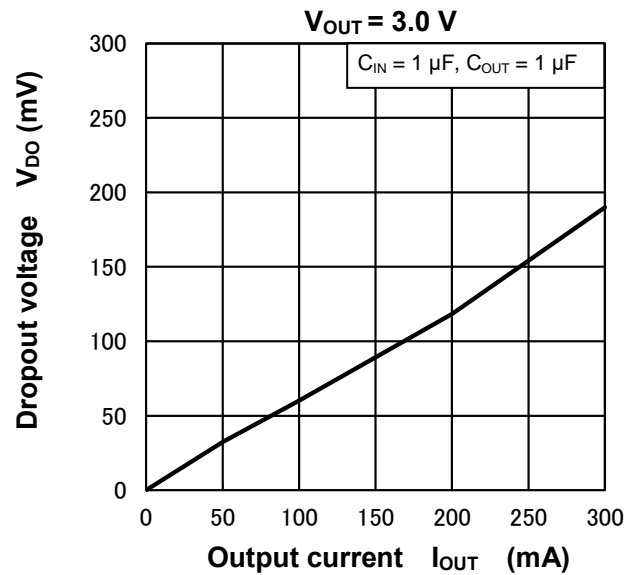
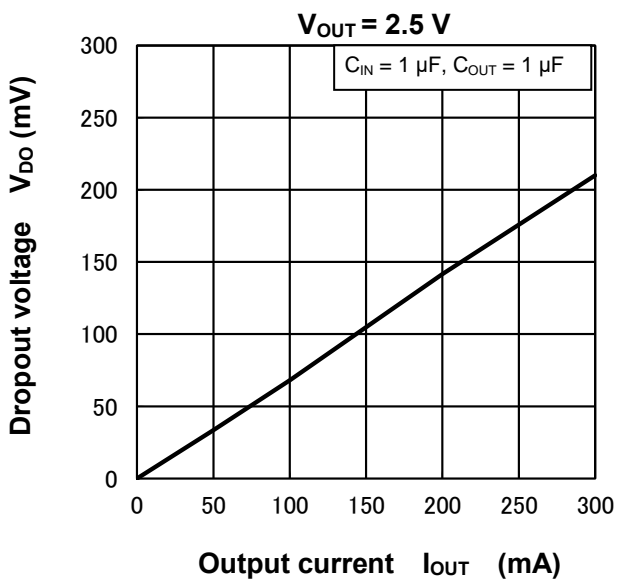
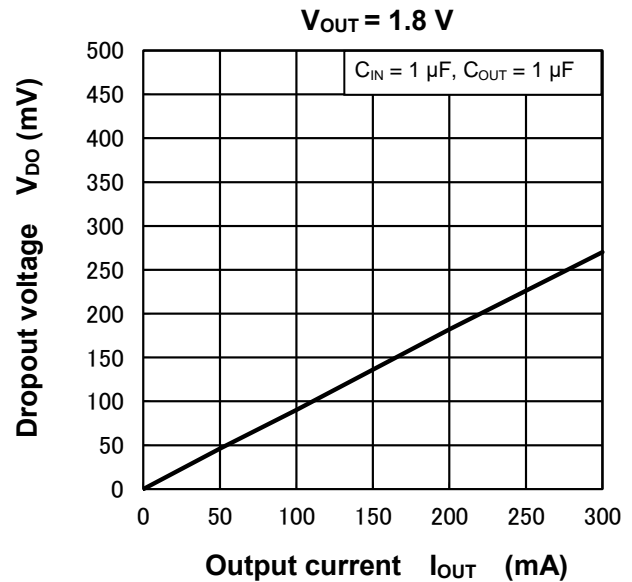
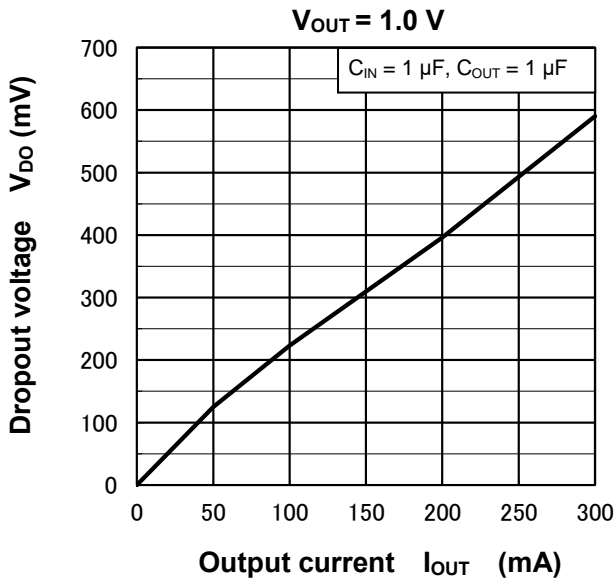


#### Output Voltage vs. Output Current



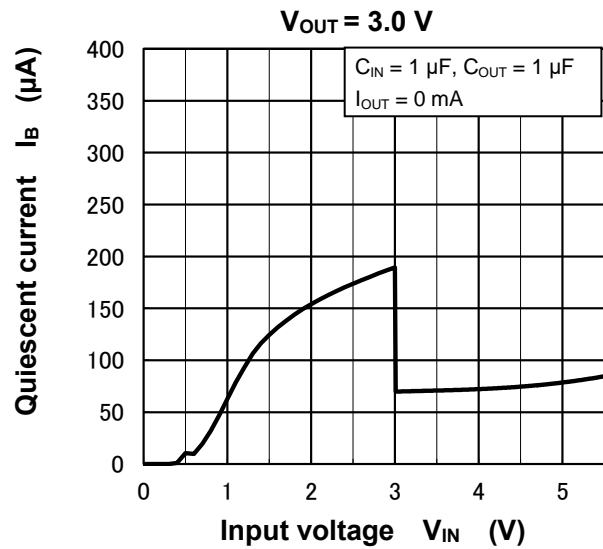
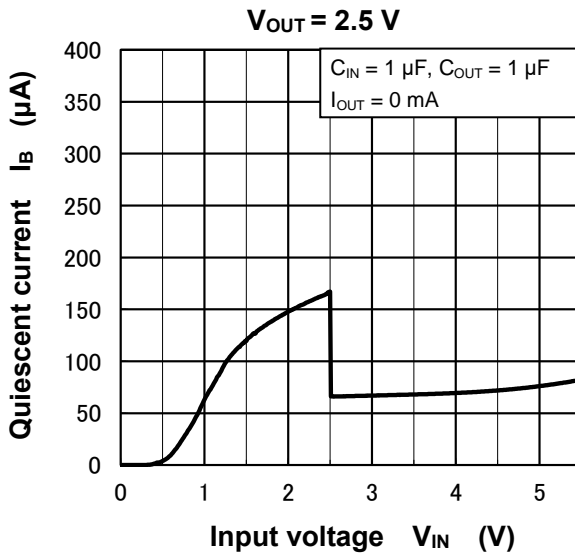
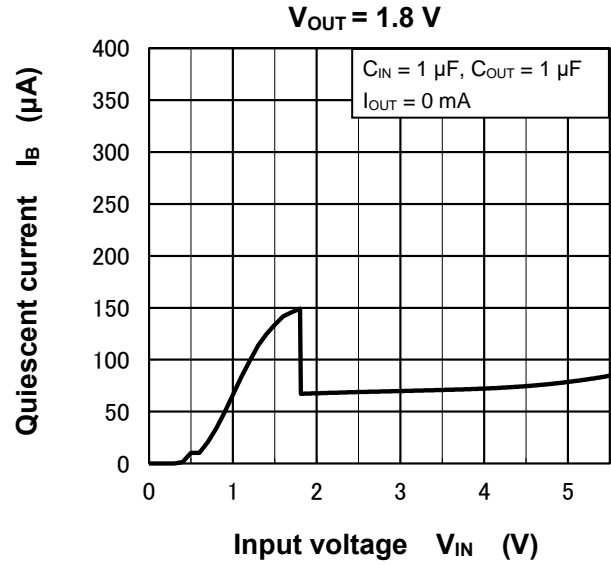
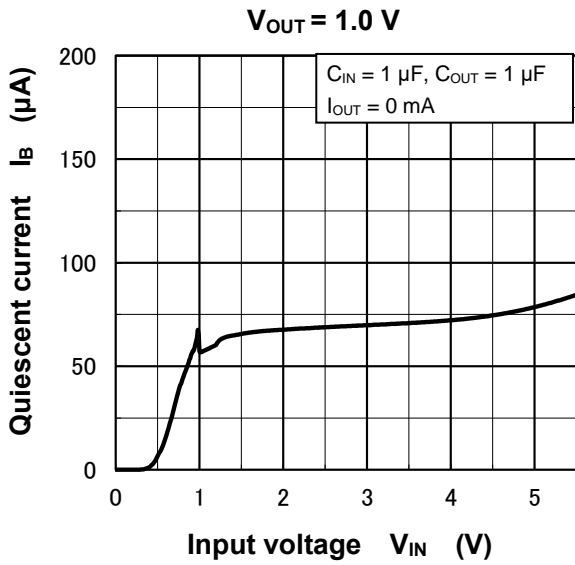


### Dropout Voltage vs. Output Current

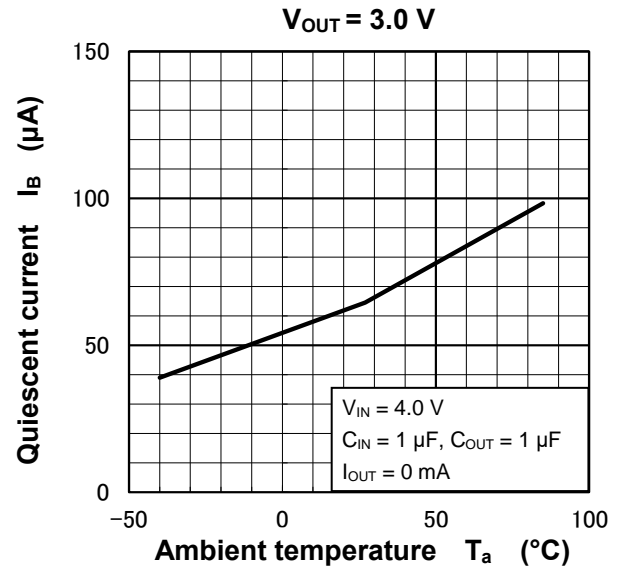
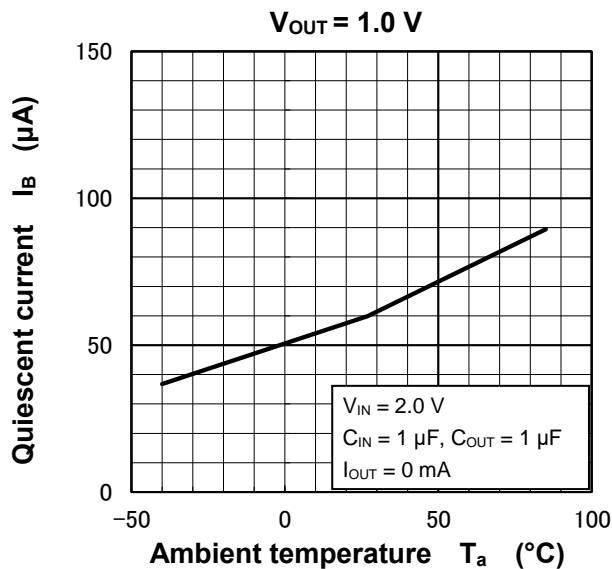




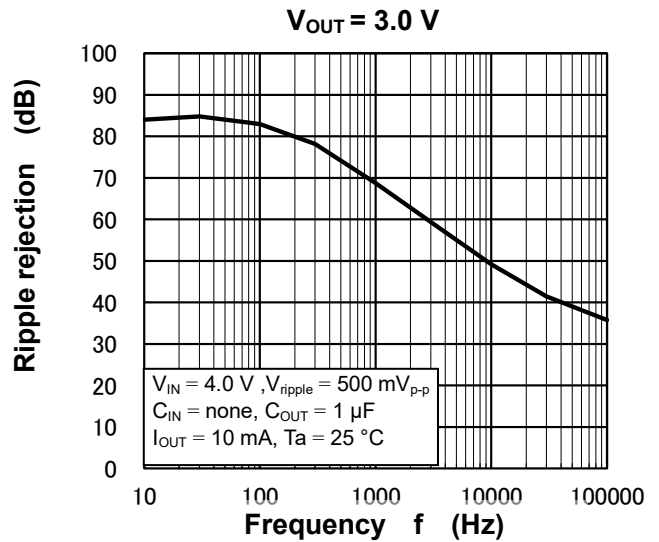
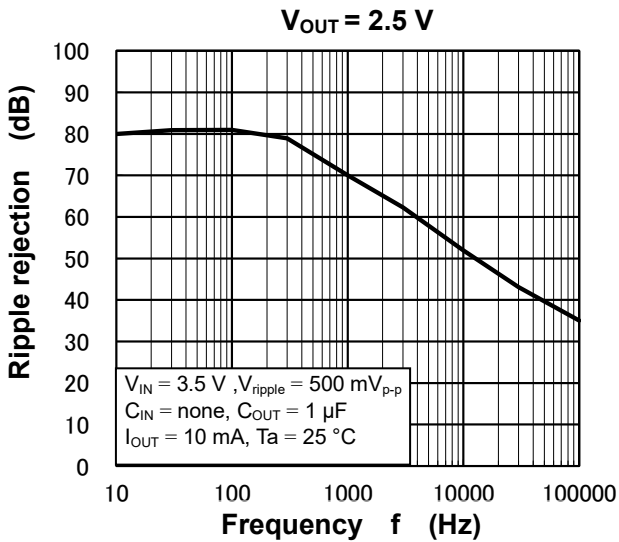
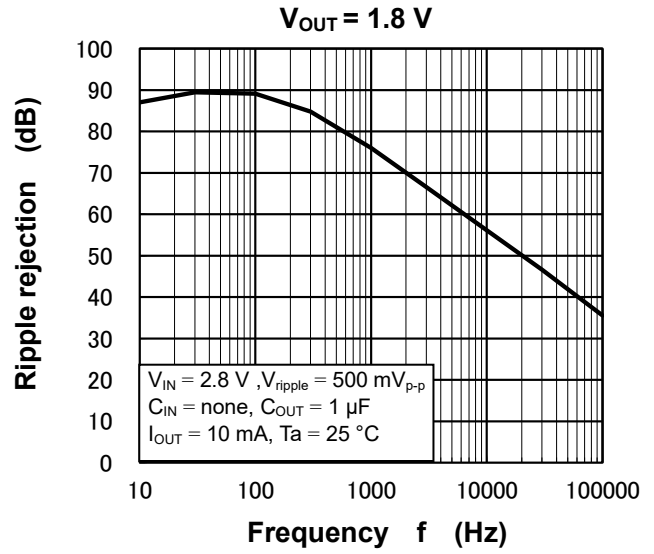
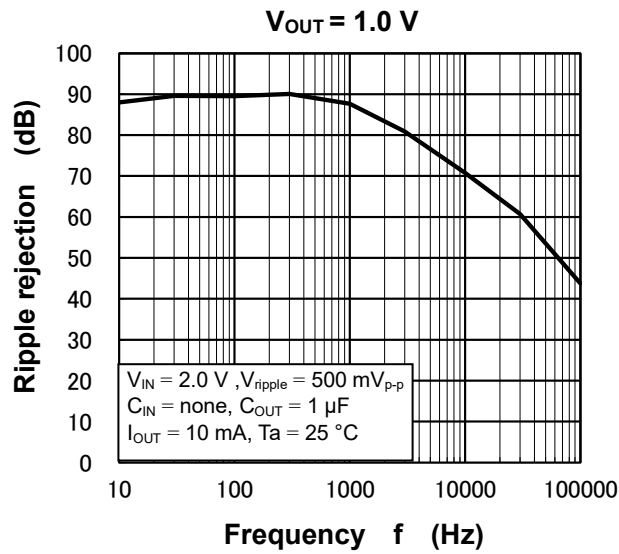
### Quiescent Current vs. Input Voltage



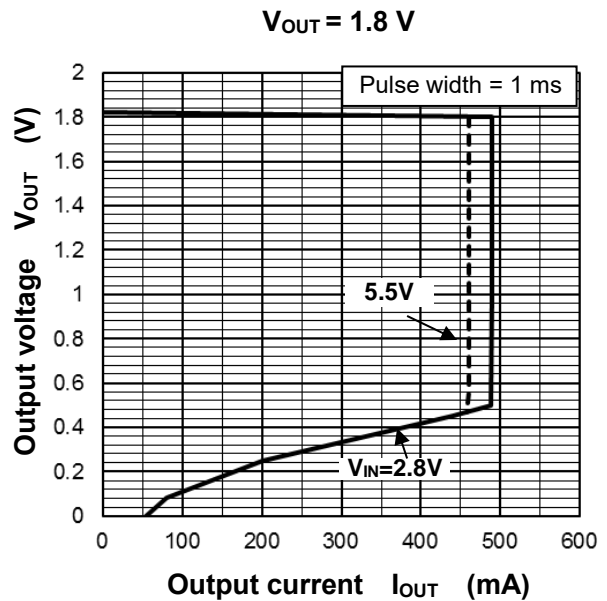
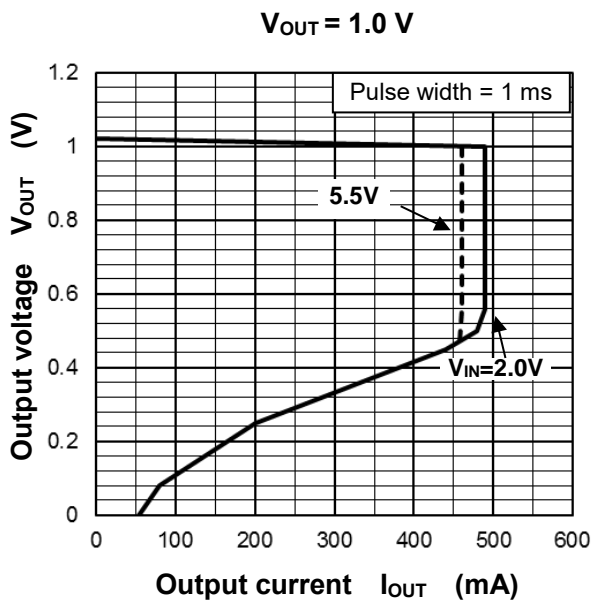
### Quiescent Current vs. Ambient Temperature

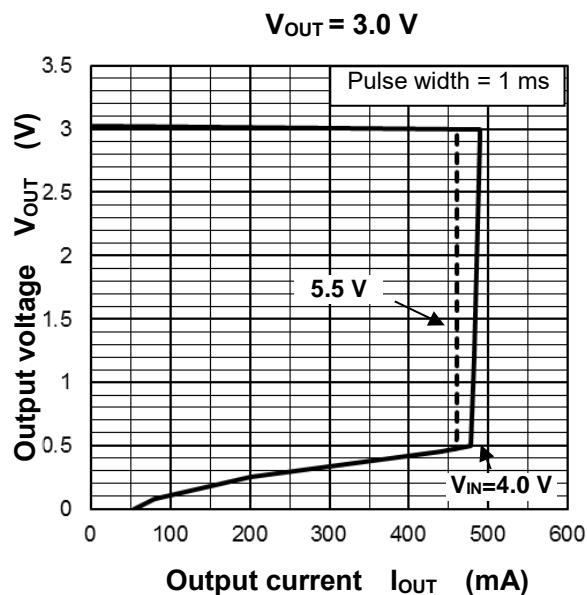
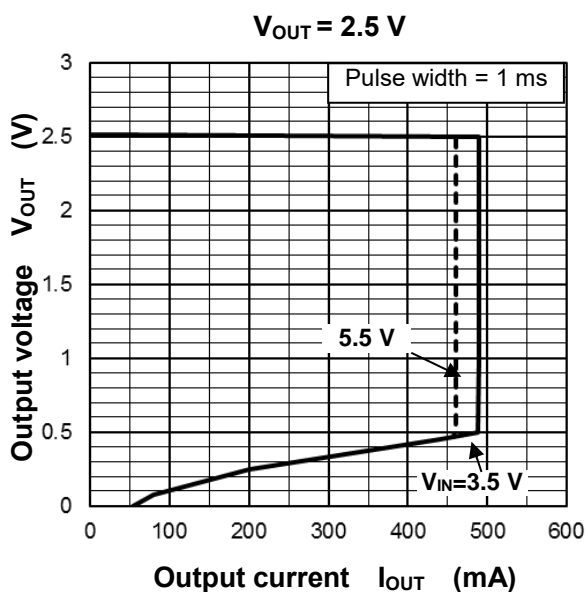


### Ripple Rejection Ratio vs. Frequency

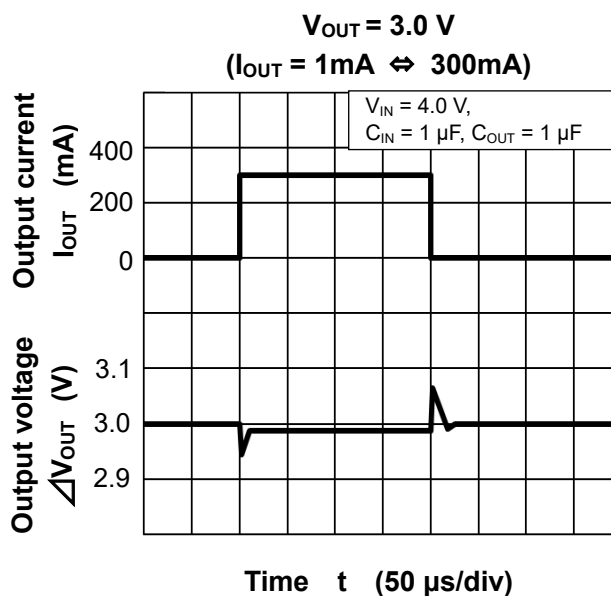
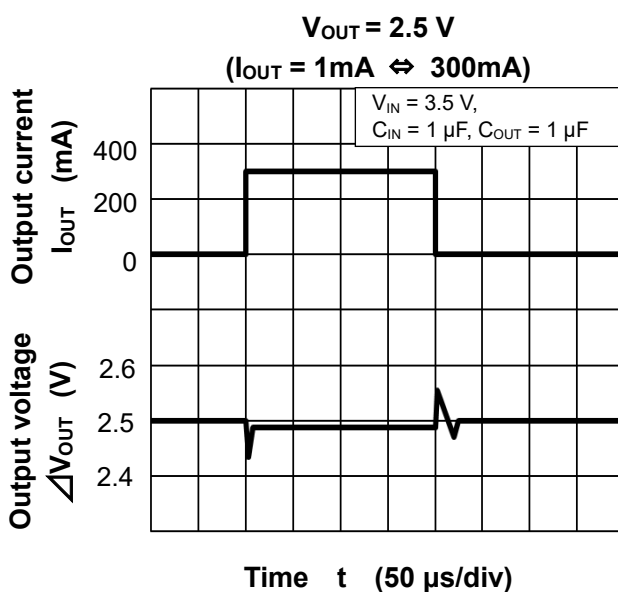
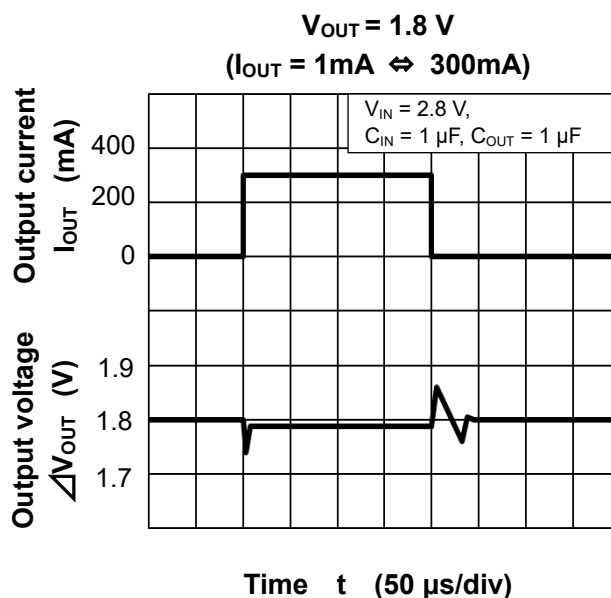
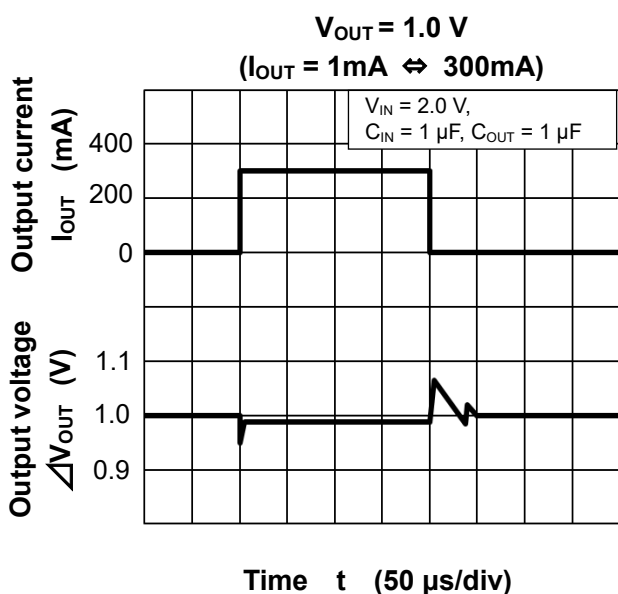


### Output Voltage vs. Output Current

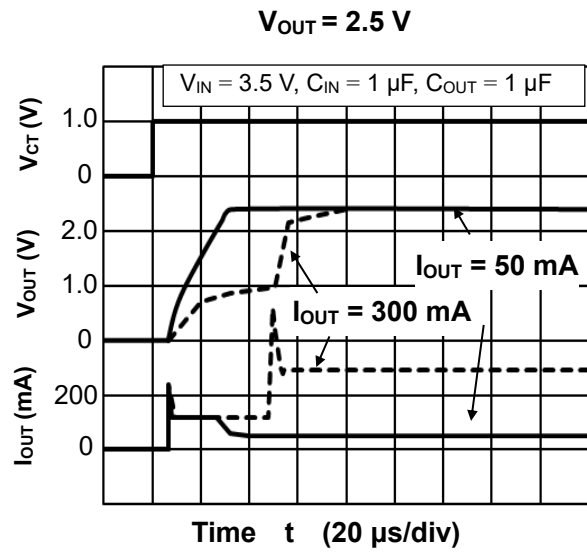
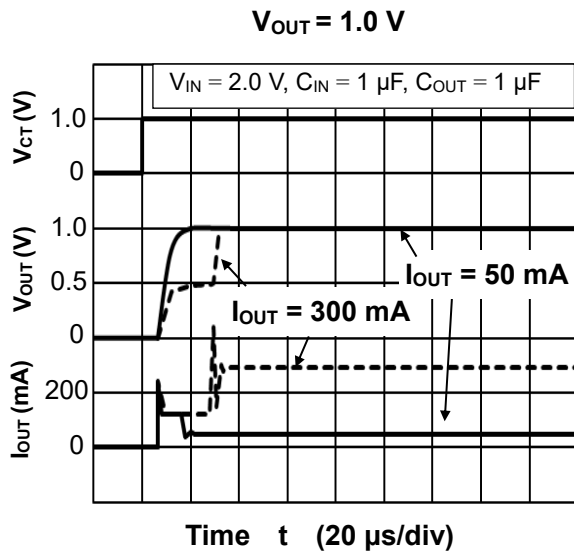




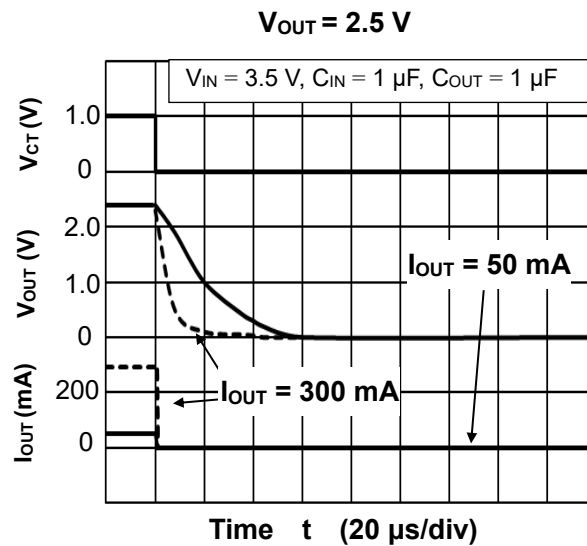
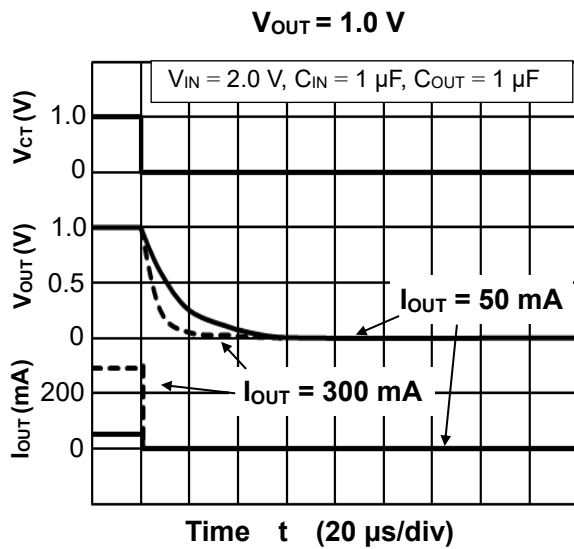
### Load Transient Response



### $t_{ON}$ Response



### $t_{OFF}$ Response

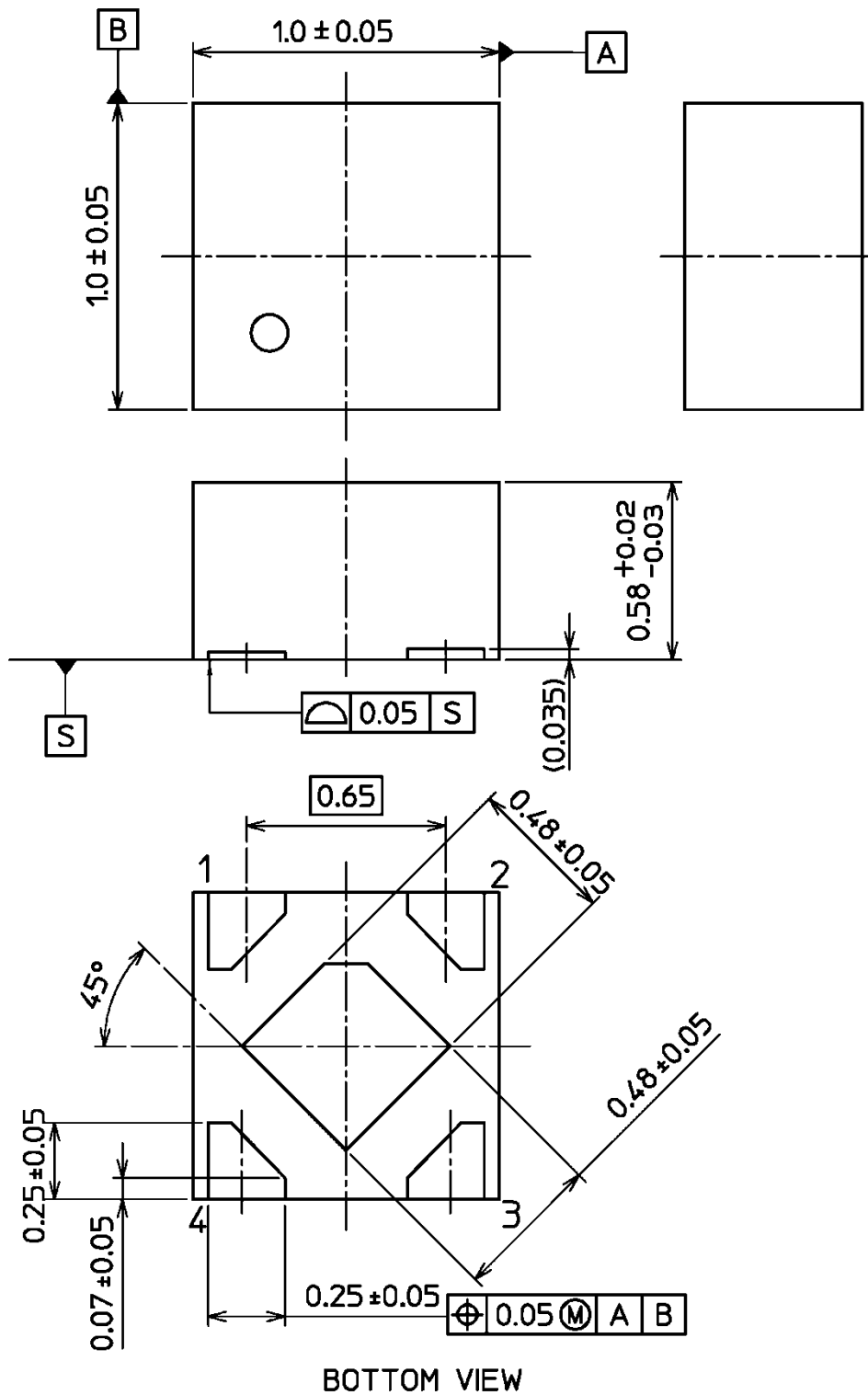


Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.

### Package Dimensions

DFN4

Unit: mm



0.04 mm (typ.) unevenness exists along the edges of the back electrode to increase shear after soldering.

Weight : 1.3 mg ( typ.)



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